## **STARPOWER**

SEMICONDUCTOR™

**IGBT** 

## **GD300HFL120C2S**

**Molding Type Module** 

1200V/300A 2 in one-package

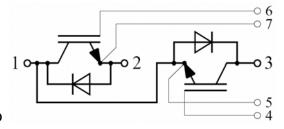
### **General Description**

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



#### **Features**

- Low V<sub>CE(sat)</sub> SPT+ IGBT technology
- 10µs short circuit capability
- V<sub>CE(sat)</sub> with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



**Equivalent Circuit Schematic** 

### **Typical Applications**

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

## Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

Symbol	Description	GD300HFL120C2S	Units
$V_{CES}$	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate-Emitter Voltage	±20	V
т	Collector Current @ T <sub>C</sub> =25°C	500	A
$I_{C}$	@ T <sub>C</sub> =80°C	300	А
I <sub>CM(1)</sub>	Pulsed Collector Current t <sub>p</sub> =1ms	600	A
$I_{\mathrm{F}}$	Diode Continuous Forward Current	300	A
$I_{FM}$	Diode Maximum Forward Current	600	A
$P_{\mathrm{D}}$	Maximum Power Dissipation @ T <sub>j</sub> =150℃	1645	W
$T_{SC}$	Short Circuit Withstand Time @ T <sub>j</sub> =125℃	10	μs
$T_{j}$	Maximum Junction Temperature	150	$^{\circ}\!\mathbb{C}$
$T_{STG}$	Storage Temperature Range	-40 to +125	$^{\circ}\!\mathbb{C}$
$V_{\rm ISO}$	Isolation Voltage RMS,f=50Hz,t=1min	2500	V
Mounting Torque	Power Terminal Screw:M6	2.5 to 5.0	N.m
wiounting forque	Mounting Screw:M6	3.0 to 5.0	N.m

#### **Notes:**

(1) Repetitive rating: Pulse width limited by max. junction temperature

### **Electrical Characteristics of IGBT** $T_C$ =25 $^{\circ}$ C unless otherwise noted

### **Off Characteristics**

Symbol	Parameter	<b>Test Conditions</b>	Min.	Typ.	Max.	Units
V <sub>(BR)CES</sub>	Collector-Emitter	T-25°C	1200			17
	Breakdown Voltage	T <sub>j</sub> =25℃				v
I <sub>CES</sub>	Collector Cut-Off Current	$V_{\text{CE}}=V_{\text{CES}}, V_{\text{GE}}=0V,$			5.0	A
		T <sub>j</sub> =25 ℃				mA
$I_{GES}$	Gate-Emitter Leakage	$V_{GE}=V_{GES},V_{CE}=0V,$			400	nA
	Current	T <sub>j</sub> =25℃			400	

#### **On Characteristics**

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
$V_{\text{GE(th)}}$	Gate-Emitter Threshold Voltage	$I_{C}=12.0$ mA, $V_{CE}=V_{GE}$ , $T_{j}=25$ °C	5.0	6.2	7.0	V
V <sub>CE(sat)</sub>	Collector to Emitter	$I_{C}$ =300A, $V_{GE}$ =15V, $T_{j}$ =25°C		2.00	2.45	V
	Saturation Voltage	$I_{C}$ =300A, $V_{GE}$ =15V, $T_{j}$ =125°C		2.20		

### **Switching Characteristics**

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
t <sub>d(on)</sub>	Turn-On Delay Time			574		ns
t <sub>r</sub>	Rise Time			133		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V -600VI -200A		563		ns
$\overline{t_{\mathrm{f}}}$	Fall Time	$V_{CC}=600V,I_{C}=300A,$		120		ns
Eon	Turn-On Switching	$R_G$ =4.7 $\Omega$ , $V_{GE}$ =±15 $V$ , $T_i$ =25 $^{\circ}$ C		23.9		mJ
Lon	Loss			23.7		1113
$E_{\text{off}}$	Turn-Off Switching			25.3		mJ
Loff	Loss			23.3		1113
t <sub>d(on)</sub>	Turn-On Delay Time			604		ns
$t_r$	Rise Time			137		ns
$t_{d(off)}$	Turn-Off Delay Time	V -600VI -200A		629		ns
$t_{\rm f}$	Fall Time	$V_{CC}=600V,I_{C}=300A,$ $R_{G}=4.7\Omega,V_{GE}=\pm15V,$		167		ns
Eon	Turn-On Switching	$T_i=125^{\circ}C$		31.5		mJ
$\mathcal{L}_{ ext{on}}$	Loss	1 <sub>j</sub> -125 C				
$E_{\text{off}}$	Turn-Off Switching			35.9		mJ
Loff	Loss					
Cies	Input Capacitance			21.2		nF
Coes	Output Capacitance	$V_{CE}=25V, f=1MHz,$		1.42		nF
	Reverse Transfer	V <sub>GE</sub> =0V		0.94		E
$C_{res}$	Capacitance			0.94		nF
$I_{SC}$		$t_{S^{C}} \leq 10 \mu s, V_{GE} = 15 V,$ $T_{j} = 125 ^{\circ}C, V_{CC} = 900 V,$				
	SC Data			1800		A
		$V_{CEM} \leq 1200V$				
R <sub>Gint</sub>	Internal Gate Resistance			1.0		Ω
L <sub>CE</sub>	Stray Inductance				20	nН
	Module Lead Resistance,	T <sub>C</sub> =25°C		0.35		mΩ
R <sub>CC'+EE'</sub>	Terminal to Chip	1C-23 C				111 75

# **Electrical Characteristics of DIODE** T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	<b>Test Conditions</b>		Min.	Тур.	Max.	Units
$V_{\mathrm{F}}$	Diode Forward	I -200 A	T <sub>j</sub> =25℃		1.82	2.25	V
	Voltage	$I_F=300A$	T <sub>j</sub> =125℃		1.95		] v
Qr	Dagayanad Changa		T <sub>j</sub> =25℃		20.2		
	Recovered Charge	$I_F = 300A$ ,	T <sub>j</sub> =125℃		40.1		μС
$I_{RM}$	Peak Reverse	$V_R = 600V$ ,	T <sub>j</sub> =25℃		170		A
	Recovery Current	di/dt=-2360A/μs,	T <sub>j</sub> =125℃		250		
E <sub>rec</sub>	Reverse Recovery	V <sub>GE</sub> =-15V	T <sub>j</sub> =25℃		8.2		an I
	Energy		T <sub>j</sub> =125℃		21.7		mJ

## **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case (per IGBT)		0.076	K/W
$R_{ heta JC}$	Junction-to-Case (per DIODE)		0.100	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.035		K/W
Weight	Weight of Module	300		g

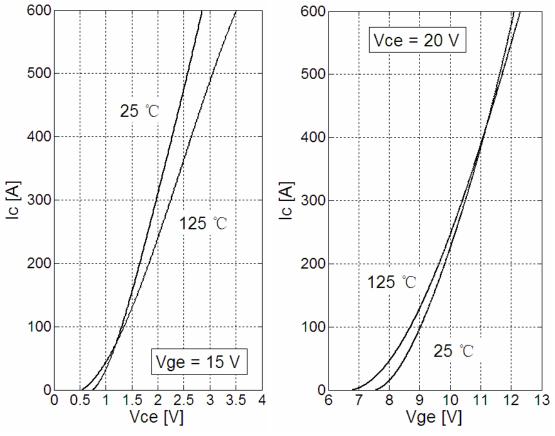


Fig 1. IGBT Typical Output Characteristics Fig 2. IGBT Typical Transfer Characteristics

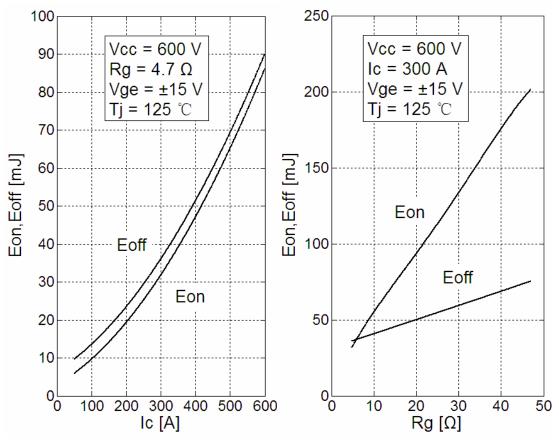


Fig 3. IGBT Switching Loss vs. I<sub>C</sub>

Fig 4. IGBT Switching Loss vs.  $R_{\rm G}\,$ 

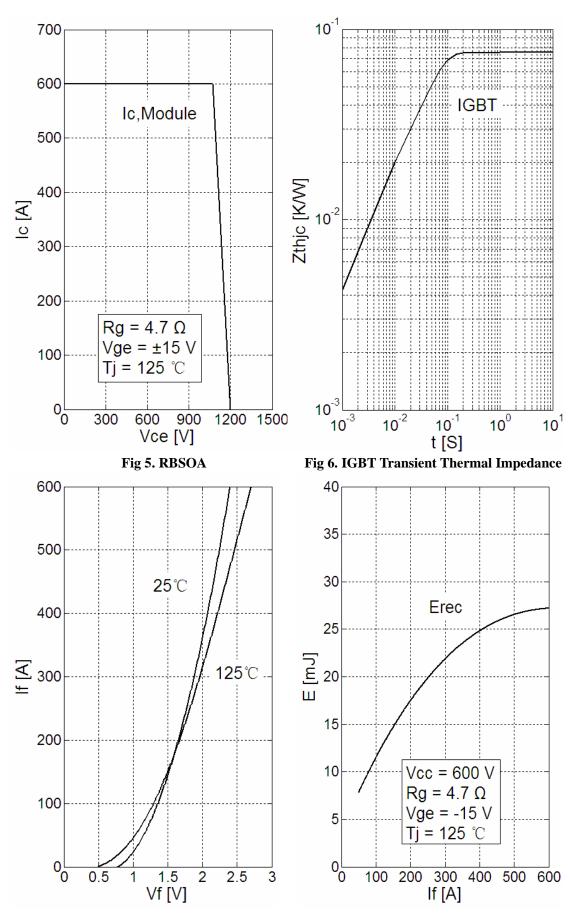


Fig 7. Diode Typical Forward Characteristics

Fig 8. Diode Switching Loss vs.  $I_{\rm F}\,$ 

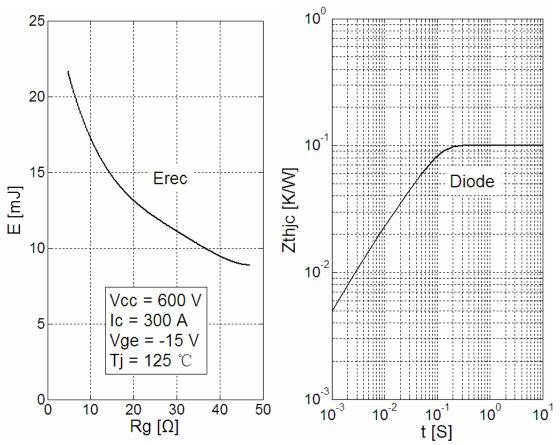
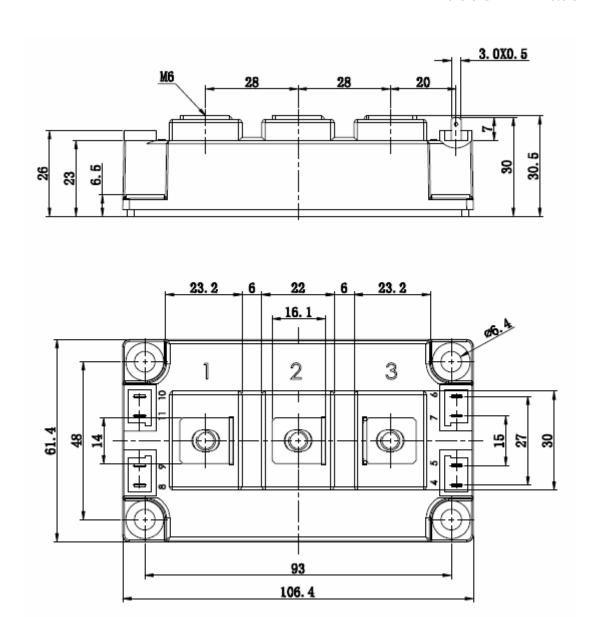


Fig 9. Diode Switching Loss vs.  $R_{\rm G}$ 

Fig 10. Diode Transient Thermal Impedance

# **Package Dimension**

#### **Dimensions in Millimeters**



#### **Terms and Conditions of Usage**

The data contained in this product datasheet is exclusively intended for technically trained staff. you and your technical departments will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to such application.

This product data sheet is describing the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its characteristics.

Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of our product, please contact the sales office, which is responsible for you (see <a href="www.powersemi.cc">www.powersemi.cc</a>), For those that are specifically interested we may provide application notes.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify.

If and to the extent necessary, please forward equivalent notices to your customers. Changes of this product data sheet are reserved.